PNZ323 (PN323)

Silicon planar type

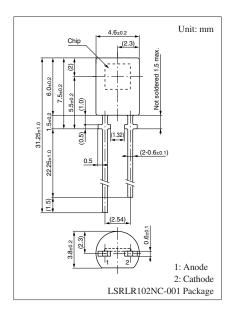
For optical control systems

■ Features

- Fast response which is well suited to high speed modulated light detection: t_r , $t_f = 50$ ns (typ.)
- High sensitivity, high reliability
- Peak emission wavelength matched with infrared light emitting diodes: $\lambda_p = 900 \text{ nm (typ.)}$
- Wide detection area, wide half-power angle: $\theta = 70^{\circ}$ (typ.)
- Adoption of visible light cutoff resin

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V _R	30	V
Power dissipation	P_{D}	100	mW
Operating ambient temperature	Topr	-30 to +85	°C
Storage temperature	T _{stg}	-40 to +100	°C

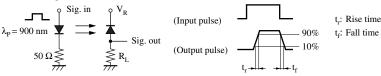


■ Electrical-Optical Characteristics $T_a = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Dark current	I_D	$V_R = 10 \text{ V}$		5	50	nA
Photocurrent *1	I_{L}	$V_R = 10 \text{ V}, L = 1000 \text{ lx}$		55		μΑ
Sensitivity to infrared radiation *2	S _{IR}	$V_R = 5 \text{ V}, H = 0.1 \text{ mW/cm}^2$	4.5	6.0		μΑ
Peak emission wavelength	λ_{p}	$V_R = 10 \text{ V}$		900		nm
Rise time *2	t _r	$V_R = 10 \text{ V}, R_L = 1 \text{ k}\Omega$		50		ns
Fall time *2	t _f			50		ns
Rise time *2	t _r	$V_R = 10 \text{ V}, R_L = 100 \text{ k}\Omega$		5		μs
Fall time *2	$t_{\rm f}$			5		μs
Terminal capacitance	C _t	$V_R = 0 V, f = 1 MHz$		70		pF
Half-power angle	θ	The angle from which photocurrent becomes 50%		70		٥

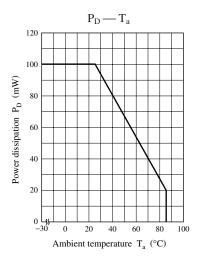
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

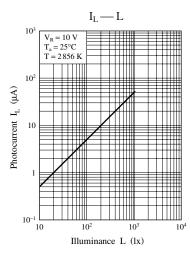
- 2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.
- 3. This device is designed be disregarded radiation.
- 4. *1: Source: Tungsten (color temperature 2856 K)
 - *2: Source: Infrared radiation ($\lambda = 940 \text{ nm}$)
 - *3: Switching time measurement circuit

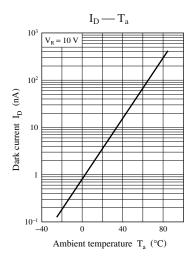


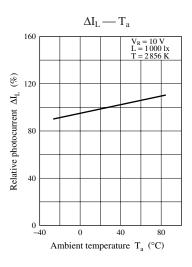
Note) The part number in the parenthesis shows conventional part number.

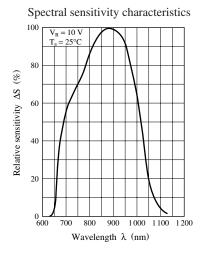
Panasonic

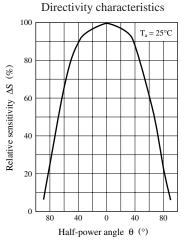


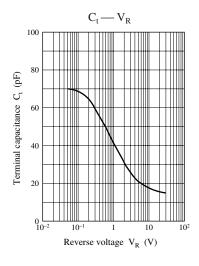


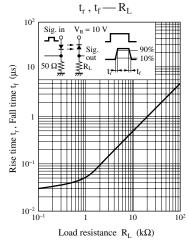


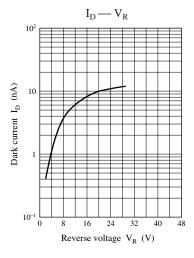












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